Notice for TAIYO YUDEN products

Please read this notice before using the TAIYO YUDEN products.

REMINDERS

Product information in this catalog is as of October 2012. All of the contents specified herein are subject to change without notice due to technical improvements, etc. Therefore, please check for the latest information carefully before practical application or usage of the Products.

Please note that Taiyo Yuden Co., Ltd. shall not be responsible for any defects in products or equipment incorporating such products, which are caused under the conditions other than those specified in this catalog or individual specification.

- Please contact Taiyo Yuden Co., Ltd. for further details of product specifications as the individual specification is available.
- Please conduct validation and verification of products in actual condition of mounting and operating environment before commercial shipment of the equipment.
- All electronic components or functional modules listed in this catalog are developed, designed and intended for use in general electronics equipment.(for AV, office automation, household, office supply, information service, telecommunications, (such as mobile phone or PC) etc.). Before incorporating the components or devices into any equipment in the field such as transportation,(automotive control, train control, ship control), transportation signal, disaster prevention, medical, public information network (telephone exchange, base station) etc. which may have direct influence to harm or injure a human body, please contact Taiyo Yuden Co., Ltd. for more detail in advance. Do not incorporate the products into any equipment in fields such as aerospace, aviation, nuclear control, submarine system, military, etc. where higher safety and reliability are especially required.

In addition, even electronic components or functional modules that are used for the general electronic equipment, if the equipment or the electric circuit require high safety or reliability function or performances, a sufficient reliability evaluation check for safety shall be performed before commercial shipment and moreover, due consideration to install a protective circuit is strongly recommended at customer's design stage.

- The contents of this catalog are applicable to the products which are purchased from our sales offices or distributors (so called "TAIYO YUDEN's official sales channel").

 It is only applicable to the products purchased from any of TAIYO YUDEN's official sales channel.
- Please note that Taiyo Yuden Co., Ltd. shall have no responsibility for any controversies or disputes that may occur in connection with a third party's intellectual property rights and other related rights arising from your usage of products in this catalog. Taiyo Yuden Co., Ltd. grants no license for such rights.
- Caution for export

 Certain items in this catalog may require specific procedures for export according to "Foreign Exchange and Foreign Trade Control Law" of Japan, "U.S. Export Administration Regulations", and other applicable regulations. Should you have any question or inquiry on this matter, please contact our sales staff.

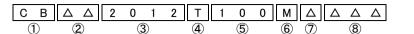
WIRE-WOUND CHIP POWER INDUCTORS(CB SERIES)





REFLOW

■PARTS NUMBER



①Series name

Code	Series name
CB	Wound chip power inductor

2Characteristics

Code	Characteristics
ΔΔ	Standard
ΔC	High current
ΔL	Low profile
MF	Low loss

③Dimensions (L × W)

Code	Type (inch)	Dimensions (L×W)[mm]
1608	1608 (0603)	1.6 × 0.8
2012	2012 (0805)	2.0 × 1.25
2016	2016 (0806)	2.0 × 1.6
2518	2518(1007)	2.5 × 1.8
3225	3225(1210)	3.2 × 2.5

4 Packaging

Code	Packaging
Т	Taping

△=Blank space

5Nominal inductance

Code (example)	Nominal inductance [μ H]
1R0	1.0
100	10
101	100

※R=Decimal point

6Inductance tolerance

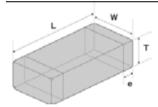
Code	Inductance tolerance
K	±10%
М	±20%

7Special code

Code	Special code
Δ	Standard
R	Low Rdc type

®Internal code

■STANDARD EXTERNAL DIMENSIONS / STANDARD QUANTITY



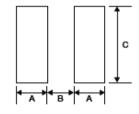
Tuna	1	w	т		Standard quantity [pcs]		
Туре	L	VV	•	е	Paper tape	Embossed tape	
CBMF1608	1.6±0.2	0.8±0.2	0.8 ± 0.2	0.45±0.15	_	3000	
CBMF1008	(0.063 ± 0.008)	(0.031 ± 0.008)	(0.031 ± 0.008)	(0.016 ± 0.006)		3000	
OD 1 2012	2.0±0.2	1.25±0.2	0.9 ± 0.1	0.5 ± 0.2	4000		
CB L2012	(0.079 ± 0.008)	(0.049 ± 0.008)	(0.035 ± 0.004)	(0.020 ± 0.008)	4000	_	
CB 2012	2.0±0.2	1.25±0.2	1.25±0.2	0.5 ± 0.2		3000	
CB C2012	(0.079 ± 0.008)	(0.049 ± 0.008)	(0.049 ± 0.008)	(0.020 ± 0.008)	_		
CB 2016	2.0±0.2	1.6±0.2	1.6±0.2	0.5±0.2	_	2000	
CB C2016	(0.079 ± 0.008)	(0.063 ± 0.008)	(0.063 ± 0.008)	(0.020 ± 0.008)	_	2000	
CB 2518	2.5±0.2	1.8±0.2	1.8±0.2	0.5±0.2		0000	
CB C2518	(0.098 ± 0.008)	(0.071 ± 0.008)	(0.071 ± 0.008)	(0.020 ± 0.008)	_	2000	
CBC3225	3.2±0.2	2.5±0.2	2.5±0.2	0.6±0.3		1000	
OBC3225	(0.126 ± 0.008)	(0.098 ± 0.008)	(0.098 ± 0.008)	(0.024 ± 0.012)	_	1000	

Unit:mm(inch)

Recommended Land Patterns

Surface Mounting

- Mounting and soldering conditions should be checked beforehand.
- •Applicable soldering process to these products is reflow soldering only.



Туре	Α	В	С
MF1608	0.55	0.7	1.0
2012	0.60	1.0	1.45
2016	0.60	1.0	1.8
2518	0.60	1.5	2.0
3218	0.85	1.7	2.0
3225	0.85	1.7	2.7

Unit:mm

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●1608(0603)type

● 1000 (0000) type	F1000 (0000) type									
		Nominal inductance		Self-resonant	DC Resistance	Rated current ※) [mA]		Measuring		
Parts number	EHS	[μ H]	Inductance tolerance	frequency [MHz] (min.)	$[\Omega](\pm 30\%)$	Saturation current Idc1		frequency[MHz]		
CBMF1608T1R0M	RoHS	1.0	±20%	100	0.09	290	770	7.96		
CBMF1608T2R2M	RoHS	2.2	±20%	80	0.17	190	560	7.96		
CBMF1608T3R3M	RoHS	3.3	±20%	60	0.22	170	500	7.96		
CBMF1608T4R7M	RoHS	4.7	±20%	45	0.24	145	470	7.96		
CBMF1608T100[]	RoHS	10	±10%, ±20%	32	0.36	115	380	2.52		
CBMF1608T220[]	RoHS	22	±10%, ±20%	16	1.0	70	230	2.52		
CBMF1608T470∏	RoHS	47	±10%, ±20%	11	2.5	50	140	2.52		

2012 (0805) type

	EHS Nom	Nominal inductance		Self-resonant frequency [MHz] (min.)	DO Decistance	Rated current ※)[mA]		Measuring
Parts number		[μ H]	Inductance tolerance		DC Resistance [Ω](±30%)	Saturation current Idc1	Temperature rise current Idc2	frequency[MHz]
CB 2012T1R0M	RoHS	1.0	±20%	100	0.15	500	900	7.96
CB 2012T2R2M	RoHS	2.2	±20%	80	0.23	410	770	7.96
CB 2012T3R3M	RoHS	3.3	±20%	55	0.30	330	650	7.96
CB 2012T4R7M	RoHS	4.7	±20%	45	0.40	300	580	7.96
CB 2012T6R8M	RoHS	6.8	±20%	38	0.47	250	540	7.96
CB 2012T100[]	RoHS	10	±10%, ±20%	32	0.70	190	440	2.52
CB 2012T100□R	RoHS	10	±10%, ±20%	32	0.50	200	520	2.52
CB 2012T150[]	RoHS	15	±10%, ±20%	28	1.3	170	320	2.52
CB 2012T220[]	RoHS	22	±10%, ±20%	16	1.7	135	280	2.52
CB 2012T470[]	RoHS	47	±10%, ±20%	11	3.7	90	190	2.52
CB 2012T680[]	RoHS	68	±10%, ±20%	10	6.0	70	140	2.52
CB 2012T101[]	RoHS	100	±10%, ±20%	8	7.0	60	130	0.796

		Non-Small State of the second		Self-resonant	DC Resistance [Ω](±30%)	Rated curren	Managemen	
Parts number	EHS	Nominal inductance [μ H]	Inductance tolerance	frequency [MHz] (min.)		Saturation current Idc1	Temperature rise current Idc2	Measuring frequency[MHz]
CB C2012T1R0M	RoHS	1.0	±20%	100	0.19	700	840	7.96
CB C2012T2R2M	RoHS	2.2	±20%	70	0.33	530	640	7.96
CB C2012T4R7M	RoHS	4.7	±20%	45	0.50	360	520	7.96
CB C2012T100[]	RoHS	10	±10%, ±20%	40	1.2	240	340	2.52
CB C2012T220[]	RoHS	22	±10%, ±20%	16	3.7	170	190	2.52
CB C2012T470[]	RoHS	47	±10%, ±20%	11	5.8	120	150	2.52

		Nominal inductance		Self-resonant	DC Resistance	Rated curren	t ※)[mA]	Managara
Parts number	EHS	[μ H]	Inductance tolerance	frequency [MHz] (min.)	$[\Omega](\pm 30\%)$	Saturation current Idc1	Temperature rise current Idc2	Measuring frequency[MHz]
CB L2012T1R0M	RoHS	1.0	±20%	100	0.15	620	950	0.1
CB L2012T2R2M	RoHS	2.2	±20%	80	0.39	440	590	0.1
CB L2012T4R7M	RoHS	4.7	±20%	45	0.66	275	490	0.1
CB L2012T100M	RoHS	10	±20%	32	1.0	205	370	0.1
CB L2012T220M	RoHS	22	±20%	23	2.1	150	250	0.1
CB L2012T470M	RoHS	47	±20%	11	4.2	100	140	0.1

2016(0806)type

		N. C. I.S. I.		Self-resonant	DO D	Rated curren	t ※)[mA]	
Parts number	EHS	Nominal inductance [μ H]	Inductance tolerance	frequency [MHz] (min.)	DC Resistance [Ω](±30%)	Saturation current Idc1	Temperature rise current Idc2	Measuring frequency[MHz]
CB 2016T1R0M	RoHS	1.0	±20%	100	0.09	600	1,100	7.96
CB 2016T1R5M	RoHS	1.5	±20%	80	0.11	550	1,000	7.96
CB 2016T2R2M	RoHS	2.2	±20%	70	0.13	510	1,000	7.96
CB 2016T3R3M	RoHS	3.3	±20%	55	0.20	400	800	7.96
CB 2016T4R7M	RoHS	4.7	±20%	45	0.25	340	740	7.96
CB 2016T6R8M	RoHS	6.8	±20%	38	0.35	300	600	7.96
CB 2016T100□	RoHS	10	±10%, ±20%	32	0.50	250	520	2.52
CB 2016T150[]	RoHS	15	±10%, ±20%	28	0.70	210	440	2.52
CB 2016T220[]	RoHS	22	±10%, ±20%	16	1.0	165	370	2.52
CB 2016T330□	RoHS	33	±10%, ±20%	14	1.7	130	270	2.52
CB 2016T470[]	RoHS	47	±10%, ±20%	11	2.4	110	240	2.52
CB 2016T680[]	RoHS	68	±10%, ±20%	10	3.0	90	210	2.52
CB 2016T101[]	RoHS	100	±10%, ±20%	8	4.5	70	170	0.796

		Nominal inductance		Self-resonant	DC Resistance	Rated curren	t ※)[mA]	Measuring
Parts number	EHS	[μ H]	Inductance tolerance	frequency [MHz] (min.)	[Ω](±30%)	Saturation current Idc1	Temperature rise current Idc2	frequency[MHz]
CB C2016T1R0M	RoHS	1.0	±20%	100	0.10	1,100	1,100	7.96
CB C2016T1R5M	RoHS	1.5	±20%	80	0.15	1,000	1,000	7.96
CB C2016T2R2M	RoHS	2.2	±20%	70	0.20	750	720	7.96
CB C2016T3R3M	RoHS	3.3	±20%	55	0.27	600	610	7.96
CB C2016T4R7M	RoHS	4.7	±20%	45	0.37	550	530	7.96
CB C2016T6R8M	RoHS	6.8	±20%	38	0.59	450	450	7.96
CB C2016T100[]	RoHS	10	±10%, ±20%	32	0.82	380	350	2.52
CB C2016T150[]	RoHS	15	±10%, ±20%	28	1.2	300	300	2.52
CB C2016T220[]	RoHS	22	±10%, ±20%	16	1.8	250	240	2.52
CB C2016T330[]	RoHS	33	±10%, ±20%	14	2.8	220	220	2.52
CB C2016T470[]	RoHS	47	±10%, ±20%	11	4.3	150	150	2.52
CB C2016T680[]	RoHS	68	±10%, ±20%	10	7.0	130	130	2.52
CB C2016T101[]	RoHS	100	±10%, ±20%	8	8.0	110	110	0.796

^{• ☐} Please specify the Inductance tolerance code (Kor M)

[%]) The saturation current value (Idc1) is the DC current value having inductance decrease down to 30%. (at 20°C) %) The temperature rise current value (Idc2) is the DC current value having temperature increase up to 40°C. (at 20°C)

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2518(1007)type

2318(1007) type				Self-resonant	505	Rated curren	t ※)[mA]	
Parts number	EHS	Nominal inductance [μ H]	Inductance tolerance	frequency [MHz] (min.)	DC Resistance [Ω](±30%)	Saturation current Idc1	Temperature rise current Idc2	Measuring frequency[MHz]
CB 2518T1R0M	RoHS	1.0	±20%	100	0.06	1,200	1,500	7.96
CB 2518T1R5M	RoHS	1.5	±20%	80	0.07	650	1,400	7.96
CB 2518T2R2M	RoHS	2.2	±20%	68	0.09	510	1,300	7.96
CB 2518T3R3M	RoHS	3.3	±20%	54	0.11	440	1,200	7.96
CB 2518T4R7MR	RoHS	4.7	±20%	46	0.10	310	1,200	7.96
CB 2518T4R7M	RoHS	4.7	±20%	46	0.13	340	1,100	7.96
CB 2518T6R8M	RoHS	6.8	±20%	38	0.15	270	930	7.96
CB 2518T100[]	RoHS	10	±10%, ±20%	30	0.25	250	820	2.52
CB 2518T150[]	RoHS	15	±10%, ±20%	23	0.32	180	650	2.52
CB 2518T220□	RoHS	22	±10%, ±20%	19	0.50	165	580	2.52
CB 2518T330□	RoHS	33	±10%, ±20%	15	0.70	130	460	2.52
CB 2518T470□	RoHS	47	±10%, ±20%	12	0.95	110	420	2.52
CB 2518T680[]	RoHS	68	±10%, ±20%	9.5	1.5	70	310	2.52
CB 2518T101[]	RoHS	100	±10%, ±20%	9.0	2.1	60	260	0.796
CB 2518T151[]	RoHS	150	±10%, ±20%	7.0	3.2	55	210	0.796
CB 2518T221[]	RoHS	220	±10%, ±20%	5.5	4.5	50	180	0.796
CB 2518T331	RoHS	330	±10%, ±20%	4.5	7.0	40	140	0.796
CB 2518T471[]	RoHS	470	±10%, ±20%	3.5	10	35	120	0.796
CB 2518T681[]	RoHS	680	±10%, ±20%	3.0	17	30	90	0.796
CB 2518T102[]	RoHS	1000	±10%, ±20%	2.4	24	25	75	0.252

		M		Self-resonant	DO D	Rated curren	t ※)[mA]	
Parts number	EHS	Nominal inductance [μ H]	Inductance tolerance	frequency [MHz] (min.)	DC Resistance [Ω](±30%)	Saturation current Idc1	Temperature rise current Idc2	Measuring frequency[MHz]
CB C2518T1R0M	RoHS	1.0	±20%	100	0.08	1,000	1,200	7.96
CB C2518T1R5M	RoHS	1.5	±20%	80	0.11	950	1,190	7.96
CB C2518T2R2M	RoHS	2.2	±20%	68	0.13	890	1,100	7.96
CB C2518T3R3M	RoHS	3.3	±20%	54	0.16	730	1,020	7.96
CB C2518T4R7M	RoHS	4.7	±20%	41	0.20	680	920	7.96
CB C2518T6R8M	RoHS	6.8	±20%	38	0.30	550	740	7.96
CB C2518T100[]	RoHS	10	±10%, ±20%	30	0.36	480	680	2.52
CB C2518T150[]	RoHS	15	±10%, ±20%	23	0.65	350	500	2.52
CB C2518T220[]	RoHS	22	±10%, ±20%	19	0.77	320	460	2.52
CB C2518T330□	RoHS	33	±10%, ±20%	15	1.5	270	320	2.52
CB C2518T470[]	RoHS	47	±10%, ±20%	12	1.9	240	290	2.52
CB C2518T680□	RoHS	68	±10%, ±20%	9.5	2.8	200	200	2.52
CB C2518T101[]	RoHS	100	±10%, ±20%	9.0	3.7	160	170	0.796
CB C2518T151[]	RoHS	150	±10%, ±20%	7.0	6.1	140	130	0.796
CB C2518T221[]	RoHS	220	±10%, ±20%	5.5	8.4	115	110	0.796
CB C2518T331[]	RoHS	330	±10%, ±20%	4.5	12.3	100	90	0.796
CB C2518T471[]	RoHS	470	±10%, ±20%	3.5	22	80	70	0.796
CB C2518T681[]	RoHS	680	±10%, ±20%	3.0	28	65	60	0.796

3225(1210)type

3225(1210)type								
		Nominal inductance		Self-resonant	DC Resistance	Rated curren	t ※)[mA]	Measuring
Parts number	EHS	[µ H]	Inductance tolerance	frequency [MHz] (min.)	[Ω](±30%)	Saturation current Idc1	Temperature rise current Idc2	frequency[MHz]
CB C3225T1R0MR	RoHS	1.0	±20%	250	0.055	2,000	1,440	0.1
CB C3225T1R5MR	RoHS	1.5	±20%	220	0.060	2,000	1,310	0.1
CB C3225T2R2MR	RoHS	2.2	±20%	190	0.080	2,000	1,130	0.1
CB C3225T3R3MR	RoHS	3.3	±20%	160	0.095	2,000	1,040	0.1
CB C3225T4R7MR	RoHS	4.7	±20%	70	0.100	1,250	1,010	0.1
CB C3225T6R8MR	RoHS	6.8	±20%	50	0.120	950	940	0.1
CB C3225T100[]R	RoHS	10	±10%, ±20%	23	0.133	900	900	0.1
CB C3225T150[]R	RoHS	15	±10%, ±20%	20	0.195	730	850	0.1
CB C3225T220[]R	RoHS	22	±10%, ±20%	17	0.27	620	780	0.1
CB C3225T330[]R	RoHS	33	±10%, ±20%	13	0.41	500	570	0.1
CB C3225T470[R	RoHS	47	±10%, ±20%	10	0.67	390	480	0.1
CB C3225T680[]R	RoHS	68	±10%, ±20%	8.0	1.0	320	410	0.1
CB C3225T101□R	RoHS	100	±10%, ±20%	6.0	1.4	270	340	0.1
CB C3225T221[]R	RoHS	220	±10%, ±20%	3.0	2.5	190	190	0.1
CB C3225T821∏R	RoHS	820	±10%, ±20%	1.8	12	110	110	0.1
CB C3225T102□R	RoHS	1000	±10%, ±20%	1.6	13	100	100	0.1

^{• []} Please specify the Inductance tolerance code(Kor M)

[%]) The saturation current value (Idc1) is the DC current value having inductance decrease down to 30%.(at 20°C)

[%]) The temperature rise current value (Idc2) is the DC current value having temperature increase up to 40°C.(at 20°C)

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WIRE-WOUND CHIP INDUCTORS (LB SERIES), WIRE-WOUND CHIP POWER INDUCTORS (CB SERIES), WIRE-WOUND CHIP INDUCTORS FOR SIGNAL LINES (LB SERIES M TYPE)

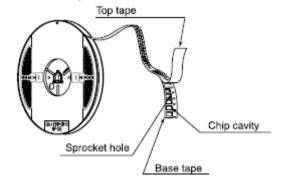
PACKAGING

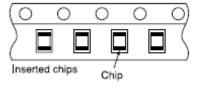
1 Minimum Quantity

Turne	Standard Qu	antity [pcs]
Туре	Paper Tape	Embossed Tape
LB C3225	_	1000
CB C3225		1000
LB 3218	_	2000
LB R2518		
LB C2518		
LB 2518	_	2000
CB 2518		
CB C2518		
LBM2016		
LB C2016		
LB 2016	_	2000
CB 2016		
CB C2016		
LB 2012		
LB C2012		
LB R2012	_	3000
CB 2012		
CB C2012		
CB L2012	4000	_
LB 1608	4000	_
LBMF1608	_	3000
CBMF1608		3000

②Tape material

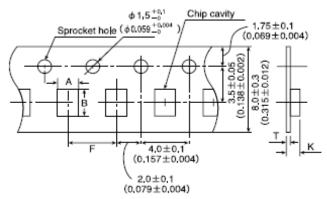
Embossed tape





3Taping Dimensions

- Embossed Tape (0.315 inches wide)
- Card board carrier tape (0.315 inches wide)

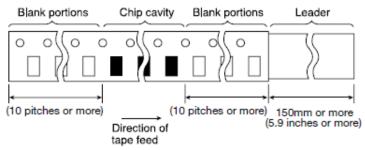


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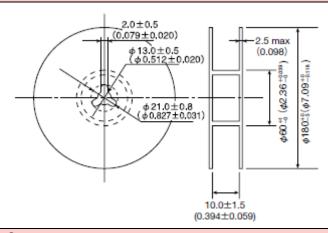
T	Chip	cavity	Insertion pitch	Tape th	ickness
Туре	Α	В	F	Т	K
LBM2016	1.75±0.1 (0.069±0.004)	2.1 ± 0.1 (0.083 \pm 0.004)	4.0±0.1 (0.157±0.004)	0.3±0.05 (0.012±0.002)	1.9max. (0.075max.)
LB C3225 CB C3225	2.8±0.1 (0.110±0.004)	3.5 ± 0.1 (0.138 ± 0.004)	4.0±0.1 (0.157±0.004)	0.3±0.05 (0.012±0.002)	4.0max. (0.157max.)
LB 3218	2.1±0.1 (0.083±0.004)	3.5 ± 0.1 (0.138 ± 0.004)	4.0±0.1 (0.157±0.004)	0.3±0.05 (0.012±0.002)	2.2max. (0.087max.)
LB 2518 CB 2518 LB C2518 CB C2518 LB R2518	2.15±0.1 (0.085±0.004)	2.7±0.1 (0.106±0.004)	4.0±0.1 (0.157±0.004)	0.3±0.05 (0.012±0.002)	2.2max. (0.087max.)
LB 2016 CB 2016 LB C2016 CB C2016	1.75±0.1 (0.069±0.004)	2.1±0.1 (0.083±0.004)	4.0±0.1 (0.157±.004)	0.3±0.05 (0.012±0.002)	1.9max. (0.075max.)
LB 2012 CB 2012 LB C2012 CB C2012 LB R2012	1.45±0.1 (0.057±0.004)	2.25±0.1 (0.089±0.004)	4.0±0.1 (0.157±0.004)	0.25±0.05 (0.010±0.002)	1.45max. (0.057max.)
CB L2012	1.55±0.1 (0.061±0.004)	2.3 ± 0.1 (0.091±0.004)	4.0±0.1 (0.157±0.004)	1.1max. (0.043max.)	1.1max. (0.043max.)
LB 1608	1.0±0.1 (0.039±0.004)	1.8±0.1 (0.071±0.004)	4.0±0.1 (0.157±0.004)	1.1max. (0.043max.)	1.1max. (0.043max.)
LBMF1608 CBMF1608	1.1±0.1 (0.043±0.004)	1.9±0.1 (0.075±0.004)	4.0±0.1 (0.157±0.004)	0.25±0.05 (0.010±0.002)	1.2max. (0.047max.)

Unit:mm(inch)

4 Leader and Blank Portion

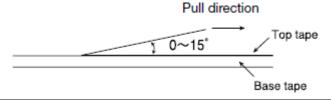


⑤Reel Size



©Top Tape Strength

The top tape requires a peel-off force 0.2 to 0.7N in the direction of the arrow as illustrated below.



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WIRE-WOUND CHIP INDUCTORS (LB SERIES), WIRE-WOUND CHIP POWER INDUCTORS (CB SERIES), WIRE-WOUND CHIP INDUCTORS FOR SIGNAL LINES (LB SERIES M TYPE)

■RELIABILITY DATA

	LBC, LBR, LBMF Series CBC, CBL, CBMF Series		
Specified Value CB,	CBC, CBL, CBMF Series		
		40 1 40500 /* 1 11 15	
LBM	A Cardan	-40~+105°C (Including self-generated heat)	
	vi Series		
2. Storage Temperature F	Range (after soldering)		
LB, I	LBC, LBR, LBMF Series		
Specified Value CB,	CBC, CBL, CBMF Series	-40~+85°C	
LBM	// Series		
Test Methods and LB.	CB Series:		
Remarks Plea	ase refer the term of \H 7. storage conditions \H in precautions	5.	
<u> </u>			
3.Rated Current			
LB,	LBC, LBR, LBMF Series		
Specified Value CB,	CBC, CBL, CBMF Series	Within the specified tolerance	
LBM	// Series		
4.Inductance			
	LBC, LBR, LBMF Series		
	CBC, CBL, CBMF Series	Within the specified tolerance	
	M Series	The specified colorande	
	LBC·LBR·CB·CBC·CBL·LBMF·CBMF·LBM Series		
	easuring equipmet :LCR Mater(HP4285A or its eq	guivalent)	
-			
5.Q			
LB,	LBC, LBR, LBMF Series		
Specified Value CB,	CBC, CBL, CBMF Series	_	
LBM	M Series	Within the specified tolerance	
Test Methods and LBM	M Series		
Remarks Me	easuring equipment : LCR Mater(HP4285A or its equ	uivalent)	
6.DC Resisitance			
LB,	LBC, LBR, LBMF Series		
Specified Value CB,	CBC, CBL, CBMF Series	Within the specified tolerance	
LBM	// Series		
Test Methods and Remarks	asuring equipment : DC Ohmmeter (HIOKI 3227 or its equiv	valent)	
7.Self-Resonant Frequence	icy		
LB,	LBC, LBR, LBMF Series		
Specified Value CB,	CBC, CBL, CBMF Series	Within the specified tolerance	
LBM	M Series		
Test Methods and Remarks	asuring equipment : Impedance analyzer(HP4291A or its e	quivalent)	

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8.Temperature Characteristic LBM2016 Inductance change: Within ±5% LB1608 LB2012 LBR2012 CB2012 Inductance change: Within ± 20% CBL2012 LB2016 CB2016 LB2518 Specified Value LBR2518 CB2518 LBC3225 CBC3225 CBMF1608 Inductance change : Within $\pm 25\%$ LBMF1608 LBC2016 CBC2016 LBC2518 CBC2518 LB3218 LBC2012 CBC2012 Inductance change: Within ±35% Test Methods and Change of maximum inductance deviation in step 1-5 Remarks Temperature (°C) Step LB, CB Series 20 2 **-40** 3 20 (Reference temperature) 4 +85 (Maximum operating temperature) 5 20

9.Rasistance to Fle	xure of Substrate	
	LB, LBC, LBR, LBMF Series	
Specified Value	CB, CBC, CBL, CBMF Series	No damage.
	LBM Series	
Test Methods and Remarks	Warp : 2mm(LB·LBC·LBR·CB·CBC·CBL·LBM·L Test substrate : Board according to JIS C0051 Thickness : 0.8mm(LB·LBMF·CBMF1608) : 1.0mm(Others) Pressing jig 10 10 10 10 10 10 10 10 10 1	BMF•CBMF Series)

10.Body Strength					
	LB, LBC, LBR, LBMF Series				
Specified Value	CB, CBC, CBL, CBMF Series	No damage.			
	LBM Series				
Test Methods and Remarks	LB·LBC·LBR·CB·CBC·CBL·LBM Applied force : 10N Duration : 10sec. LB1608·LBMF1608·CBMF1608 Applied force : 5N Duration : 10sec.				

11.Adhesion of tern	ninal electrode				
	LB, LBC, LBR, LB	MF Series			
Specified Value	CB, CBC, CBL, CE	BMF Series	No abnormality.		
	LBM Series				
Test Methods and	LB·LBC·LBR·CB	·CBC·CBL·LBM·LBMF·CBMF	·		
Remarks	Applied force	: 10N to X and Y directions			
	Duration	: 5 sec.			
	Test substrate	: Printed board			
	LB1608 • CBMF160	08 • LBMF1608			
	Applied force	: 5N toX and Y directions			
	Dration	: 5 sec.			
	Test substrate	: Printed board			

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	bration				
	LB, LBC, LBR, LBMF Series		Inductance change: Within±10% No significant abnormality in appearance. Inductance change: Within±5% No significant abnormality in appearance.		
Specified Value	CB, CBC, CBL, CBMF Series				
Specifical Value	LBM Series				
Test Methods and Remarks	LB·LBR·LBC·CB·CBC Vibration type Directions Freuency range Amplitude Mounting method Recovery	• CBL • LBM • LBMF • CBMF : According : A : 2 hrs each in X, Y and Z directions : 10 to 55 to 10 Hz (1min.) : 1.5mm : Soldering onto printed board : At least 2 hrs of recovery under the hs.			
13.Drop test					
13.Drop test	LD LDO LDD LDME C-	4			
0 '6 11/1	LB, LBC, LBR, LBMF Se		-		
Specified Value	CB, CBC, CBL, CBMF S	eries	 		
_	LBM Series				
1					
14.Solderability	T		1		
	LB, LBC, LBR, LBMF Se		<u> </u>		
Specified Value	CB, CBC, CBL, CBMF S	eries	At least 90% of surface of terminal electrode is covered by new		
	LBM Series				
Test Methods and Remarks	LB·LBC·LBR·CB·CBC·CBL·LBM·LBMF·CBMF: Solder temperature : 245±5°C Duration : 5±0.5sec Flux : Methanol solution with 25% of colophony				
15.Resistance to so	oldering				
	LB, LBC, LBR, LBMF Se	ries			
Specified Value	CB, CBC, CBL, CBMF Se		Inductance change : Within±10%		
oposmou valas	LBM Series	5.100	Industance change: Within + 504		
	LBM Series Inductance change: Within±5% LB·LBC·LBR·CB·CBL·LBM·LBMF·CBMF: 3 times of reflow oven at 230°C MIN for 40sec. with peak temperature at 260 °C for 5sec.				
Test Methods and Remarks					
Remarks	3 times of reflow oven a				
	3 times of reflow oven a	at 230°C MIN for 40sec. with peak te			
Remarks 16.Resisitance to s	3 times of reflow oven a colvent LB, LBC, LBR, LBMF Se	at 230°C MIN for 40sec. with peak te	emperature at 260 °C for 5sec.		
Remarks	3 times of reflow oven a colvent LB, LBC, LBR, LBMF Se CB, CBC, CBL, CBMF Se	at 230°C MIN for 40sec. with peak te			
Remarks 16.Resisitance to s	3 times of reflow oven a colvent LB, LBC, LBR, LBMF Se	at 230°C MIN for 40sec. with peak te	emperature at 260 °C for 5sec.		
Remarks 16.Resisitance to s Specified Value Test Methods and	olvent LB, LBC, LBR, LBMF Se CB, CBC, CBL, CBMF So LBM Series Solvent temperature Type of solvent	at 230°C MIN for 40sec. with peak te	emperature at 260 °C for 5sec.		
Remarks 16.Resisitance to s Specified Value Test Methods and	olvent LB, LBC, LBR, LBMF Se CB, CBC, CBL, CBMF So LBM Series Solvent temperature Type of solvent	at 230°C MIN for 40sec. with peak te	emperature at 260 °C for 5sec.		
Remarks 16.Resisitance to s Specified Value Test Methods and Remarks	3 times of reflow oven a colvent LB, LBC, LBR, LBMF Se CB, CBC, CBL, CBMF Se LBM Series Solvent temperature Type of solvent Cleaning conditions	at 230°C MIN for 40sec. with peak terries eries : Room temperature : Isopropyl alcohol : 90s. Immersion and cleaning.	emperature at 260 °C for 5sec.		
Remarks 16.Resisitance to s Specified Value Test Methods and Remarks 17.Thermal shock	3 times of reflow oven a colvent LB, LBC, LBR, LBMF Se CB, CBC, CBL, CBMF Sc LBM Series Solvent temperature Type of solvent Cleaning conditions LB, LBC, LBR, LBMF Se	at 230°C MIN for 40sec. with peak terries Pries Room temperature Isopropyl alcohol 90s. Immersion and cleaning.	Inductance change: Within±10%		
Remarks 16.Resisitance to s Specified Value Test Methods and Remarks	3 times of reflow oven a colvent LB, LBC, LBR, LBMF Se CB, CBC, CBL, CBMF Se LBM Series Solvent temperature Type of solvent Cleaning conditions	at 230°C MIN for 40sec. with peak terries Pries Room temperature Isopropyl alcohol 90s. Immersion and cleaning.	Pemperature at 260 °C for 5sec. No significant abnormality in appearance		

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18.Damp heat life to	est			
. J. Damp Hoat III C	I	MF Series		
Specified Value	LB, LBC, LBR, LBMF Series CB, CBC, CBL, CBMF Series		Inductance change : Within±10%	
	CB, CBC, CBL, CBMF Series LBM Series		No significant abnormality in appearance.	
Test Methods and	Temperature	: 60±2°C		
Remarks	Humidity	: 90~95%RH		
	Duration : 1000 hrs			
	Recovery	: At least 2 hrs of recovery und	er the standard condition after the test, followed by the measurement within 48 hrs.	
19.Loading under da	amp heat life test			
Specified Value	LB, LBC, LBR, LBI	MF Series		
	CB, CBC, CBL, CBMF Series		Inductance change: Within±10%	
	LBM Series		No significant abnormality in appearance.	
Test Methods and	Temperature	: 60±2°C	<u> </u>	
Remarks	Humidity	: 90~95%RH		
	Duration	: 1000 hrs		
	Applied current Recovery	: Rated current	er the standard condition after the test, followed by the measurement within 48 hrs.	
	recovery	. At least 2 his of recovery und	of the standard condition arter the test, followed by the measurement within 40 ms.	
20.High temperature	e life test			
	LB, LBC, LBR, LBMF Series			
Specified Value	CB, CBC, CBL, CBMF Series		Inductance change : Within±10% No significant abnormality in appearance.	
	LBM Series		The digilillocate abtorniality in appearance.	
Test Methods and Remarks	Temperature	: 85±2°C		
	Duration : 1000 hrs			
Remarks			or the standard condition after the test followed by the measurement within 48 hrs	
Remarks	Recovery		er the standard condition after the test, followed by the measurement within 48 hrs.	
	Recovery	: At least 2 hrs of recovery und	er the standard condition after the test, followed by the measurement within 48 hrs.	
		: At least 2 hrs of recovery und	er the standard condition after the test, followed by the measurement within 48 hrs. Inductance change: Within±10%	
	Recovery	: At least 2 hrs of recovery und		
	Recovery emperature life test	: At least 2 hrs of recovery und	Inductance change : Within±10%	
21.Loading at high t	Recovery emperature life test	: At least 2 hrs of recovery und	Inductance change : Within±10% (LBC3225 Series : Within±20%)	
21.Loading at high t	emperature life test LB, LBC, LBR, LBI	: At least 2 hrs of recovery und	Inductance change : Within±10% (LBC3225 Series : Within±20%)	
21.Loading at high t Specified Value Test Methods and	Recovery LB, LBC, LBR, LBI CB, CBC, CBL, CE LBM Series Temperature	: At least 2 hrs of recovery und MF Series BMF Series : 85±2°C	Inductance change : Within±10% (LBC3225 Series : Within±20%)	
21.Loading at high t	Recovery LB, LBC, LBR, LBI CB, CBC, CBL, CE LBM Series Temperature Duration	: At least 2 hrs of recovery und MF Series BMF Series : 85±2°C : 1000 hrs	Inductance change : Within±10% (LBC3225 Series : Within±20%)	
21.Loading at high t Specified Value Test Methods and	Recovery LB, LBC, LBR, LBI CB, CBC, CBL, CE LBM Series Temperature	: At least 2 hrs of recovery und MF Series BMF Series : 85±2°C : 1000 hrs : Rated current	Inductance change : Within±10% (LBC3225 Series : Within±20%) No significant abnormality in appearance.	
21.Loading at high t Specified Value Test Methods and	Recovery Cemperature life test LB, LBC, LBR, LBI CB, CBC, CBL, CE LBM Series Temperature Duration Applied current	: At least 2 hrs of recovery und MF Series BMF Series : 85±2°C : 1000 hrs : Rated current	Inductance change : Within±10% (LBC3225 Series : Within±20%)	
21.Loading at high t Specified Value Test Methods and	emperature life test LB, LBC, LBR, LBI CB, CBC, CBL, CE LBM Series Temperature Duration Applied current Recovery	: At least 2 hrs of recovery und MF Series BMF Series : 85±2°C : 1000 hrs : Rated current	Inductance change : Within±10% (LBC3225 Series : Within±20%) No significant abnormality in appearance.	
21.Loading at high to Specified Value Test Methods and Remarks	emperature life test LB, LBC, LBR, LBI CB, CBC, CBL, CE LBM Series Temperature Duration Applied current Recovery	: At least 2 hrs of recovery und MF Series BMF Series : 85±2°C : 1000 hrs : Rated current : At least 2 hrs of recovery und	Inductance change: Within±10% (LBC3225 Series: Within±20%) No significant abnormality in appearance. ———————————————————————————————————	
21.Loading at high to Specified Value Test Methods and Remarks	Recovery LB, LBC, LBR, LBI CB, CBC, CBL, CE LBM Series Temperature Duration Applied current Recovery	: At least 2 hrs of recovery und MF Series BMF Series : 85±2°C : 1000 hrs : Rated current : At least 2 hrs of recovery und	Inductance change: Within±10% (LBC3225 Series: Within±20%) No significant abnormality in appearance. — er the standard condition after the test, followed by the measurement within 48 hrs. Inductance change: Within±10%	
21.Loading at high to Specified Value Test Methods and Remarks	Recovery LB, LBC, LBR, LBI CB, CBC, CBL, CE LBM Series Temperature Duration Applied current Recovery LB, LBC, LBR, LBI LB, LBC, LBR, LBI	: At least 2 hrs of recovery und MF Series : 85±2°C : 1000 hrs : Rated current : At least 2 hrs of recovery und	Inductance change: Within±10% (LBC3225 Series: Within±20%) No significant abnormality in appearance. ———————————————————————————————————	
21.Loading at high to Specified Value Test Methods and Remarks 22.Low temperature Specified Value Test Methods and	Recovery LB, LBC, LBR, LBI CB, CBC, CBL, CE LBM Series Temperature Duration Applied current Recovery LB, LBC, LBR, LBI CB, CBC, CBL, CE LB, LBC, LBR, LBI CB, CBC, CBL, CE LBM Series Temperature	: At least 2 hrs of recovery und MF Series 3MF Series : 85±2°C : 1000 hrs : Rated current : At least 2 hrs of recovery und MF Series 3MF Series : -40±2°C	Inductance change: Within±10% (LBC3225 Series: Within±20%) No significant abnormality in appearance. — er the standard condition after the test, followed by the measurement within 48 hrs. Inductance change: Within±10%	
21.Loading at high to Specified Value Test Methods and Remarks 22.Low temperature Specified Value	Recovery LB, LBC, LBR, LBI CB, CBC, CBL, CE LBM Series Temperature Duration Applied current Recovery LB, LBC, LBR, LBI CB, CBC, CBL, CE LBM Series Temperature Duration	: At least 2 hrs of recovery und MF Series BMF Series : 85±2°C : 1000 hrs : Rated current : At least 2 hrs of recovery und MF Series BMF Series : -40±2°C : 1000 hrs	Inductance change: Within±10% (LBC3225 Series: Within±20%) No significant abnormality in appearance. — er the standard condition after the test, followed by the measurement within 48 hrs. Inductance change: Within±10% No significant abnormality in appearance.	
21.Loading at high to Specified Value Test Methods and Remarks 22.Low temperature Specified Value Test Methods and	Recovery LB, LBC, LBR, LBI CB, CBC, CBL, CE LBM Series Temperature Duration Applied current Recovery LB, LBC, LBR, LBI CB, CBC, CBL, CE LB, LBC, LBR, LBI CB, CBC, CBL, CE LBM Series Temperature	: At least 2 hrs of recovery und MF Series BMF Series : 85±2°C : 1000 hrs : Rated current : At least 2 hrs of recovery und MF Series BMF Series : -40±2°C : 1000 hrs	Inductance change: Within±10% (LBC3225 Series: Within±20%) No significant abnormality in appearance. — er the standard condition after the test, followed by the measurement within 48 hrs. Inductance change: Within±10%	
21.Loading at high to Specified Value Test Methods and Remarks 22.Low temperature Specified Value Test Methods and	Recovery emperature life test LB, LBC, LBR, LBI CB, CBC, CBL, CE LBM Series Temperature Duration Applied current Recovery e life test LB, LBC, LBR, LBI CB, CBC, CBL, CE LBM Series Temperature Duration Recovery	: At least 2 hrs of recovery und MF Series BMF Series : 85±2°C : 1000 hrs : Rated current : At least 2 hrs of recovery und MF Series BMF Series : -40±2°C : 1000 hrs	Inductance change: Within±10% (LBC3225 Series: Within±20%) No significant abnormality in appearance. — er the standard condition after the test, followed by the measurement within 48 hrs. Inductance change: Within±10% No significant abnormality in appearance.	
21.Loading at high to Specified Value Test Methods and Remarks 22.Low temperature Specified Value Test Methods and Remarks	Recovery LB, LBC, LBR, LBI CB, CBC, CBL, CE LBM Series Temperature Duration Applied current Recovery LB, LBC, LBR, LBI CB, CBC, CBL, CE LBM Series Temperature Duration Recovery	: At least 2 hrs of recovery und MF Series BMF Series : 85±2°C : 1000 hrs : Rated current : At least 2 hrs of recovery und MF Series BMF Series : -40±2°C : 1000 hrs : At least 2 hrs of recovery und	Inductance change: Within±10% (LBC3225 Series: Within±20%) No significant abnormality in appearance. — er the standard condition after the test, followed by the measurement within 48 hrs. Inductance change: Within±10% No significant abnormality in appearance.	
21.Loading at high to Specified Value Test Methods and Remarks 22.Low temperature Specified Value Test Methods and Remarks	Recovery LB, LBC, LBR, LBI CB, CBC, CBL, CE LBM Series Temperature Duration Applied current Recovery LB, LBC, LBR, LBI CB, CBC, CBL, CE LBM Series Temperature Duration Recovery	: At least 2 hrs of recovery und MF Series : 85±2°C : 1000 hrs : Rated current : At least 2 hrs of recovery und MF Series MF Series : -40±2°C : 1000 hrs : At least 2 hrs of recovery und	Inductance change: Within±10% (LBC3225 Series: Within±20%) No significant abnormality in appearance. — er the standard condition after the test, followed by the measurement within 48 hrs. Inductance change: Within±10% No significant abnormality in appearance. er the standard condition after the test, followed by the measurement within 48 hrs.	
21.Loading at high to Specified Value Test Methods and Remarks 22.Low temperature Specified Value Test Methods and Remarks 23.Standard conditions	Recovery LB, LBC, LBR, LBI CB, CBC, CBL, CE LBM Series Temperature Duration Applied current Recovery LB, LBC, LBR, LBI CB, CBC, CBL, CE LBM Series Temperature Duration Recovery	: At least 2 hrs of recovery und MF Series : 85±2°C : 1000 hrs : Rated current : At least 2 hrs of recovery und MF Series MF Series : -40±2°C : 1000 hrs : At least 2 hrs of recovery und	Inductance change: Within±10% (LBC3225 Series: Within±20%) No significant abnormality in appearance. — er the standard condition after the test, followed by the measurement within 48 hrs. Inductance change: Within±10% No significant abnormality in appearance. er the standard condition after the test, followed by the measurement within 48 hrs. Standard condition after the test, followed by the measurement within 48 hrs. Unless specified, Ambient temperature is 20±15°C and the Relative humidity is 65±20%. If there is any doubt about the test results, further	
21.Loading at high to Specified Value Test Methods and Remarks 22.Low temperature Specified Value Test Methods and Remarks	emperature life test LB, LBC, LBR, LBI CB, CBC, CBL, CE LBM Series Temperature Duration Applied current Recovery life test LB, LBC, LBR, LBI CB, CBC, CBL, CE LBM Series Temperature Duration Recovery	: At least 2 hrs of recovery und MF Series : 85±2°C : 1000 hrs : Rated current : At least 2 hrs of recovery und MF Series MF Series : -40±2°C : 1000 hrs : At least 2 hrs of recovery und	Inductance change: Within±10% (LBC3225 Series: Within±20%) No significant abnormality in appearance. — er the standard condition after the test, followed by the measurement within 48 hrs. Inductance change: Within±10% No significant abnormality in appearance. er the standard condition after the test, followed by the measurement within 48 hrs. Standard condition after the test, followed by the measurement within 48 hrs. Unless specified, Ambient temperature is 20±15°C and the Relative humidity is 65±20%. If there is any doubt about the test results, further measurement shall be had within the following limits:	
21.Loading at high to Specified Value Test Methods and Remarks 22.Low temperature Specified Value Test Methods and Remarks 23.Standard conditions	Recovery LB, LBC, LBR, LBI CB, CBC, CBL, CE LBM Series Temperature Duration Applied current Recovery LB, LBC, LBR, LBI CB, CBC, CBL, CE LBM Series Temperature Duration Recovery	: At least 2 hrs of recovery und MF Series : 85±2°C : 1000 hrs : Rated current : At least 2 hrs of recovery und MF Series MF Series : -40±2°C : 1000 hrs : At least 2 hrs of recovery und	Inductance change: Within±10% (LBC3225 Series: Within±20%) No significant abnormality in appearance. — er the standard condition after the test, followed by the measurement within 48 hrs. Inductance change: Within±10% No significant abnormality in appearance. er the standard condition after the test, followed by the measurement within 48 hrs. Standard condition after the test, followed by the measurement within 48 hrs. Unless specified, Ambient temperature is 20±15°C and the Relative humidity is 65±20%. If there is any doubt about the test results, further	

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WIRE-WOUND CHIP INDUCTORS (LB SERIES), WIRE-WOUND CHIP POWER INDUCTORS (CB SERIES), WIRE-WOUND CHIP INDUCTORS FOR SIGNAL LINES (LB SERIES M TYPE)

PRECAUTIONS

1. Circuit Design

Precautions

Operating environment

1. The products described in this specification are intended for use in general electronic equipment, (office supply equipment, telecommunications systems, measuring equipment, and household equipment). They are not intended for use in mission-critical equipment or systems requiring special quality and high reliability (traffic systems, safety equipment, aerospace systems, nuclear control systems and medical equipment including life-support systems,) where product failure might result in loss of life, injury or damage. For such uses, contact TAIYO YUDEN Sales Department in advance.

2. PCB Design

Precautions

considerations

◆Land pattern design

1. Please contact any of our offices for a land pattern, and refer to a recommended land pattern of a right figure or specifications.

Technical

PRECAUTIONS

[Recommended Land Patterns]

Surface Mounting

- · Mounting and soldering conditions should be checked beforehand.
- · Applicable soldering process to those products is reflow soldering only.

3. Considerations for automatic placement

Precautions

◆Adjustment of mounting machine

- 1. Excessive impact load should not be imposed on the products when mounting onto the PC boards.
- 2. Mounting and soldering conditions should be checked beforehand.

Technical considerations

1. When installing products, care should be taken not to apply distortion stress as it may deform the products.

4. Soldering

◆Reflow soldering(LB and CB Types)

Precautions

Technical

considerations

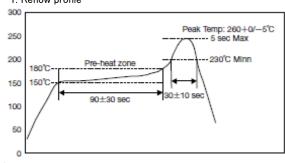
1. For reflow soldering with either leaded or lead-free solder, the profile specified in "point for controlling" is recommended.

◆Recommended conditions for using a soldering iron

1. Put the soldering iron on the land-pattern. Soldering iron's temperature - Below 350°C Duration-3 seconds or less. The soldering iron should not come in contact with inductor directly.

◆Reflow soldering(LB and CB Types)

1. Reflow profile



- ◆Recommended conditions for using a soldering iron
- 1. Components can be damaged by excessive heat where soldering conditions exceed the specified range

5. Cleaning

Precautions

◆Cleaning conditions

Washing by supersonic waves shall be avoided.

Technical considerations

◆Cleaning conditions

If washed by supersonic waves, the products might be broken.

This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/).

6. Handling	
Precautions	 ◆Handling 1. Keep the inductors away from all magnets and magnetic objects. ◆Breakaway PC boards (splitting along perforations) 1. When splitting the PC board after mounting inductors, care should be taken not to give any stresses of deflection or twisting to the board. 2. Board separation should not be done manually, but by using the appropriate devices. ◆Mechanical considerations 1. Please do not give the inductors any excessive mechanical shocks.
Technical considerations	 ♦ Handling 1. There is a case that a characteristic varies with magnetic influence. ♦ Breakaway PC boards (splitting along perforations) 1. Planning pattern configurations and the position of products should be carefully performed to minimize stress. ♦ Mechanical considerations 1. There is a case to be damaged by a mechanical shock.

Precautions	 ◆Storage 1. To maintain the solderability of terminal electrodes and to keep the packing material in good condition, temperature and humidity in the storage area should be controlled. • Recommended conditions Ambient temperature:0~40°C / Humidity:Below 70% RH The ambient temperature must be kept below 30°C even under ideal storage conditions, solderability of products electrodes may decrease as time passes. For this reason, LB type: Should be used within 6 months from the time of delivery.
Technical considerations	◆Storage 1. Under a high temperature and humidity environment, problems such as reduced solderability caused by oxidation of terminal electrodes and deterioration of taping/packaging materials may take place.